New Jersey Semi-Conductor Products, Inc.

20 STERN AVE. SPRINGFIELD, NEW JERSEY 07081 U.S.A.

General Purpose Transistor NPN Silicon





MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector Emitter Voltage	VCEO	40	Vdc
Collector-Base Voltage	V _{CBO}	60	Vdc
Emitter-Base Voltage	VEBO	6.0	Vdc
Collector Current — Continuous	IC	100	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	PD	625 5.0	mW mW/ºC
Total Power Dissipation @ T _A = 60°C	PD	450	mW
Total Device Dissipation @ T _C = 25°C Derate above 25°C	PD	1.5 12	Watts mW/ºC
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	R _{0JA}	200	°C/W
Thermal Resistance, Junction to Case	R _{0JC}	83.3	°C/W

ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Max	Unit
OFF CHARACTERISTICS			- I	
Collector – Emitter Breakdown Voltage(1) (I _C = 1.0 mAdc, I _B = 0)	V(BR)CEO	40	-	Vdc
Collector-Base Breakdown Voltage (I _C = 10 μAdc, I _E = 0)	V _(BR) CBO	60	_	Vdc
Emitter-Base Breakdown Voltage (I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	6.0	_	Vdc
Collector Cutoff Current (VCE = 30 Vdc, VEB(off) = 3.0 Vdc)	ICEX		50	nAdc
Base Cutoff Current (VCE = 30 Vdc, VEB(off) = 3.0 Vdc)	^I BL		50	nAdc

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

NJ Semi-Conductors reserves the right to change test conditions, parameter limits and package dimensions without notice. Information furnished by NJ Semi-Conductors is believed to be both accurate and reliable at the time of going to press. However, NJ Semi-Conductors assumes no responsibility for any errors or omissions discovered in its use. NJ Semi-Conductors encourages customers to verify that datasheets are current before placing orders.

Quality Semi-Conductors

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MPS3904



MP\$3904

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted) (Continued)

Characteristic	Symbol	Min	Max	Unit
ON CHARACTERISTICS(1)				
DC Current Gain ($I_C = 0.1 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 1.0 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 10 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 50 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$) ($I_C = 100 \text{ mAdc}, V_{CE} = 1.0 \text{ Vdc}$)	hfe	40 70 100 60 30		
Collector – Emitter Saturation Voltage ($I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc}$) ($I_C = 50 \text{ mAdc}, I_B = 5.0 \text{ mAdc}$)	VCE(sat)		0.2 0.3	Vdc
Base-Emitter Saturation Voltage $(I_C = 10 \text{ mAdc}, I_B = 1.0 \text{ mAdc})$ $(I_C = 50 \text{ mAdc}, I_B = 5.0 \text{ mAdc})$	VBE(sat)	0.65 —	0.85 1.1	Vdc
SMALL-SIGNAL CHARACTERISTICS				
Current–Gain — Bandwidth Product (I _C = 10 mAdc, V _{CE} = 20 Vdc, f = 100 MHz)	ŕτ	200	_	MHz
Output Capacitance (V _{CB} = 5.0 Vdc, I _E = 0, f = 1.0 MHz)	C _{obo}	_	4.0	pF
Input Capacitance (V _{EB} = 0.5 Vdc, I _C = 0, f = 1.0 MHz)	C _{ibo}	_	8.0	pF
Input Impedance (I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{ie}	1.0	10	kΩ
Voltage Feedback Ratio (I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{re}	0.5	8.0	X 10-4
Small–Signal Current Gain (I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	100	400	_
Output Admittance (I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{oe}	1.0	40	µmhos
Noise Figure (I _C = 100 μAdc, V _{CE} = 5.0 Vdc, R _S = 1.0 kΩ, f = 1.0 kHz)	NF		5.0	dB
SWITCHING CHARACTERISTICS				

Delay Time	(V _{CC} = 3.0 Vdc, V _{BE(off)} = -0.5 Vdc, I _C = 10 mAdc, i _{B1} = 1.0 mAdc)	^t d	-	35	ns
Rise Time		tr	-	50	ns
Storage Time	(V _{CC} = 3.0 Vdc, I _C = 10 mAdc,	ts	1	900	ns
Fall Time	I _{B1} = I _{B2} = 1.0 mAdc)	tf	_	90	ns

1. Pulse Test: Pulse Width \leq 300 µs, Duty Cycle \leq 2.0%.

EQUIVALENT SWITCHING TIME TEST CIRCUITS



*Total shunt capacitance of test jig and connectors

Figure 1. Turn-On Time

Figure 2. Turn-Off Time